-Cooperation Agreement for Small Form-Factor Pluggable Transceivers with OM (Optical Monitoring)

EMC Corp., IBM Corp

I. Purpose of the Cooperation Agreement (Agreement)

Each party desires to establish internationally compatible sources of a pluggable fiber optic transceiver module in support of standards for fiber optic systems including Asynchronous Transfer Mode (ATM), FDDI, Fibre Channel, Fast Ethernet and Gigabit Ethernet, and Synchronous Optical Network (SONET) / Synchronous Digital Hierarchy (SDH) applications.

Each party further desires to establish uniformity in the industry for the Transceiver "Package Dimensions", "Cage and Electrical Connector System", "Host Board Layout", "Electrical Interfaces", and "Front Panel Bezel Requirements" as described in Appendices A-B.

Each party expects that the establishment of compatible sources for an interchangeable transceiver module will allow the entire fiber optic marketplace to grow more rapidly. This enhanced marketplace growth, customer choice, and vigorous competition are the express purposes of this Agreement. Each party acknowledges this agreement provides a solution with height as a primary limiting constraint and may not provide an optimum solution for applications with different constraints.

The parties desire to establish compatible sources for additional products in the future.

II. Agreement

A. General

The parties agree to cooperate by supporting common product specifications for pluggable fiber optic transceivers with the package "Package Dimensions", "Cage and Electrical Connector System", "Host Board Layout", "Electrical Interfaces", and "Front Panel Bezel Requirements" as shown in Appendices A-B. The overall package dimensions shall not exceed the maximum indicated dimensions, and the mounting features shall be located such that the products are mechanically interchangeable with the cage and connector system. In addition the overall dimensions and mounting requirements for the cage and connector system on a circuit board shall be configured such that the products are mechanically and electrically interchangeable.

The electrical and optical specifications shall be compatible with those enumerated in the appropriate standards (i.e. the IEEE 802.3z Gigabit Ethernet standard and the ITU G.957 Synchronous Digital Hierarchy standard). Recommended circuit layouts for electrical input and output terminations, and grounding practices are also described in Appendix B.

The transceivers per this Agreement will accept an optical connector such as the duplex LC, MT-RJ or the SG connector. This Agreement does not preclude any of the parties from offering SFP with OM transceivers with other connectors.

Internal design of the SFP with OM transceiver is entirely at the discretion of each party and is not covered by this Agreement. The parties recognize that their products may not be identical, but need only meet the above criteria.

B. Licensing and Fees

No license is granted under the patents, know-how, tradesecrets or any other technology of any party to this Agreement either expressly or by implication or by estoppel. Each of the MSA parties have agreed that licenses to all required intellectual property will be made available to all interested parties under reasonable and non-discriminatory terms and conditions applicable to that MSA party. Individual parties to this Agreement may have patents, which they believe may be relevant to this Agreement. The MSA parties should be contacted individually to determine if they have patent rights, which they believe may be pertinent to this Agreement. Each party is free to seek technology or other exchanges with other firms in order to support its activities under this Agreement.

C. Scope of the Agreement

The scope of this Agreement includes transceivers with transmission rates up to 5.0 Gb/s operating over multimode and single mode fiber.

Each party agrees to be responsible for its own development, manufacturing, marketing and selling in order to supply transceivers meeting the attached specifications.

This Agreement does not preclude any party from offering other products that may not meet the attached specifications.

Each party retains complete liberty regarding its methods of implementing a supply of product, e.g., by engineering effort or by technology licensing or transfer or combination of these or other practices.

Each party also retains sole discretion in its choice of sales channels and distribution.

Each party affirms its intention to compete freely and openly in the marketplace with the parties as well as other competitors.

Each party expects to support products meeting the attached specifications for as long as marketplace conditions warrant. No specific time limit is associated with this Agreement. The determination of market condition suitability is to be made by each party individually and in each party's sole discretion.

III. Public Announcement

A. Announcing the Agreement

Each party agrees to announce this Agreement in a manner agreed upon by the parties. These announcements will mention all the parties who have signed this Agreement.

Each party agrees to seek public attention by means of such an announcement.

Each party agrees to contribute time and effort at its sole discretion toward preparing and making such an announcement.

B. Promotion of the Agreement

After the Agreement is announced, each party may advertise or otherwise promote this Agreement in any way that it deems appropriate. Mutual consent of the other party is required if such other party is to be mentioned by name.

IV. Other Vendors

A. Other Vendors Matching the Product Configuration

The parties recognize that additional vendors may choose to match the attached product specifications after this Agreement is announced.

Each party recognizes it is desirable and keeping with the intent of the Agreement for such additional vendors to support the transceiver mechanical dimensions and functional attributes described in Appendix A.

Therefore, each party agrees to encourage other vendors to support these product specifications.

B. Naming Other Vendors

Each party agrees to have written internal procedures that require such party to name the other parties when customers ask who intends to be a source for transceivers as described in this Agreement. Each party agrees for such procedures to require it to name the others regardless as to whether another of the parties has already supplied similar transceiver products to that customer.

An example of suggested wording is: "EMC, and IBM have signed a Cooperation Agreement relating to the establishment of Small Form-factor Pluggable transceivers with Optical Monitoring for multimode and single mode fiber operating up to 5.0 Gb/s data rates."

The parties are not obligated to provide any information other than the identities of the other parties. The requirements of this provision are met entirely if a party has the aforementioned written procedures and they are made available to its sales force in the same way as are other sales related procedures.

V. Future Direction

A. Current Product

Should the parties agree to further explore technical and other exchanges pertaining to the products described in this Agreement, then this shall be under a separate agreement.

B. Withdrawal

The parties recognize that at some future time it may become less feasible to offer the products envisioned by this Agreement. A party may withdraw from its commitment to cooperate at its own discretion upon a 90-day notice to the other parties. This notice is necessary to allow the other parties to discontinue mentioning the withdrawing part as a participant in this Agreement and to reconsider any jointly planned promotional activities.

VI. Limitation of Liability

With the exception of disputes arising out of intellectual property issues, no party to this Agreement shall be liable for any indirect, incidental, punitive, or consequential damages, including without limitation, lost profits or changes of good will, or similar losses, even if advised of the possibility of such damages. In addition, each party's liability under this Agreement for direct damages shall be limited to \$10,000.

Appendix A. Mechanical Interface

- A1. SFP with OM Transceiver Package Dimensions
- A2. Mating of SFP with OM Transceiver PCB to SFP with OM Electrical Connector
- A3. Host Board Layout
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Appendix B. Electrical Interface

- B1. Introduction
- B2. Pin Definitions
- B3. Timing Requirements of Control and Status I/O
- B4. Module Definition Interface and Data Field Description
- B5. Optical Monitoring Definition

Appendix C. Agreement Signatures

Appendix A. Mechanical Interface

A1. SFP with OM Transceiver Package Dimensions

A common mechanical outline is used for all SFP with OM transceivers. The package dimensions for the SFP with OM transceiver are described in Table 1 and Figures 1A and 1B.

Table 1. Dimension Table for Drawing of SFP with OM Transceiver

Designator	Dimension	Tolerance	Comments	
	(mm)	(mm)		
A	13.7	± 0.1	Transceiver width, nosepiece or front that extends inside cage	
В	8.6	± 0.1	Transceiver height, front, that extends inside cage	
С	8.5	± 0.1	Transceiver height, rear	
D	13.4	± 0.1	Transceiver width, rear	
E	1.0	Maximum	Extension of front sides outside of cage, see Note 2 Figure 1B	
F	2.3	Reference	Location of cage grounding springs from centerline, top	
G	4.2	Reference	Location of side cage grounding springs from top	
Н	2.0	Maximum	Width of cage grounding springs	
J	28.5	Minimum	Location of transition between nose piece and rear of transceiver	
K	56.5	Reference	Transceiver overall length	
L	1.1x45°	Minimum	Chamfer on bottom of housing	
М	2.0	± 0.25	Height of rear shoulder from transceiver printed circuit board	
N	2.25	± 0.1	Location of printed circuit board to bottom of transceiver	
Р	1.0	± 0.1	Thickness of printed circuit board	
Q	9.2	± 0.1	Width of printed circuit board	
R	0.7	Maximum	Width of skirt in rear of transceiver	
S	45.0	± 0.2	Length from latch shoulder to rear of transceiver	
Т	34.6	± 0.3	Length from latch shoulder to bottom opening of transceiver	
U	41.8	± 0.15	Length from latch shoulder to end of printed circuit board	
V	2.5	± 0.05	Length from latch shoulder to shoulder of transceiver outside of cage (location of positive stop).	
W	1.7	± 0.1	Clearance for actuator tines	
Х	9.0	Reference	Transceiver length extending outside of cage, see Note 2 Figure 1B	
Y	2.0	Maximum	Maximum length of top and bottom of transceiver extending outside of cage, see Note 2 Figure 1B	
Z	0.45	± 0.05	Height of latch boss	
AA	8.6	Reference	Transceiver height, front, that extends inside cage	
AB	2.6	Maximum	Length of latch boss (design optional)	
AC	45°	± 3°	Entry angle of actuator	
AD	0.3	Maximum		
AE	6.3	Reference		
AF	2.6	± 0.05	Width of latch boss (design optional)	
AG	0.40	Minimum	Maximum radius of front of latch boss, 2 places (design optional)	

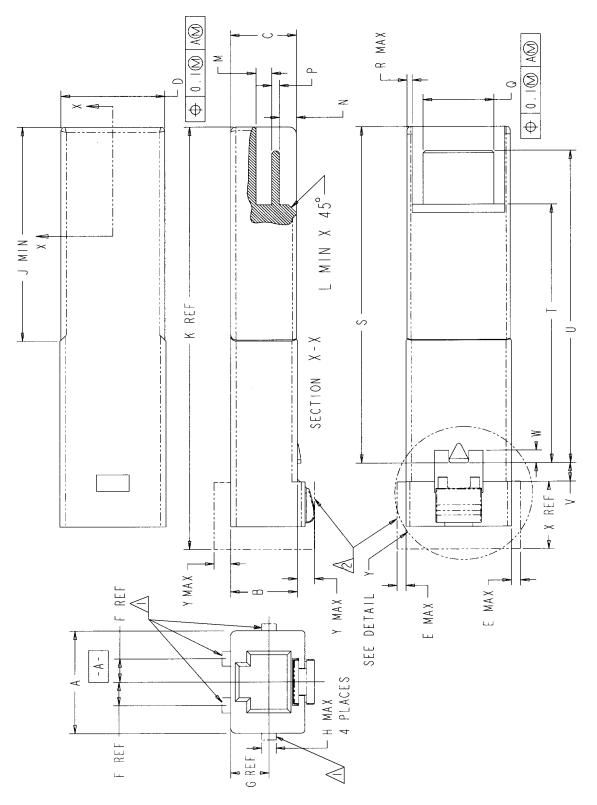
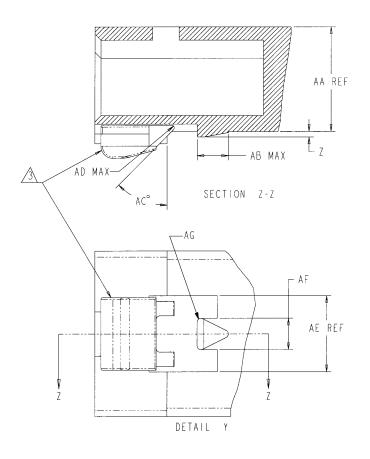


Figure 1A. Drawing of SFP with OM Transceiver



Notes:

- Cage grounding springs permitted in this area and may extend full length of transceiver, 4 places. Grounding springs may contribute a maximum force of 3.5N (Newtons) to the withdrawal force of the transceiver from the cage.
- 2. A representative MT-RJ configuration is illustrated. Indicated outline defines the preferred maximum envelope outside of the cage.
- **3**. Design of actuation method and shape is optional.
- 4. Color code: An exposed colored feature of the transceiver (a feature or surface extending outside the cage assembly) shall be color coded as follows:
 - Black or beige for multi-mode
 - Blue for single mode

Figure 1B. Drawing of SFP with OM Transceiver (Cont.)

A2. Mating of SFP with OM Transceiver PCB to SFP with OM Electrical Connector

The SFP with OM transceiver contains a printed circuit board that mates with the SFP with OM electrical connector. The pads are designed for a sequenced mating:

- First mate ground contacts
- Second mate power contacts
- Third mate signal contacts

The design of the mating portion of the transceiver printed circuit board is illustrated in Figure 2 and the electrical pad layout is illustrated in Figure 3. A typical contact pad plating for the printed circuit board is 0.38 micrometers minimum hard gold over 1.27 micrometers minimum thick nickel. Other plating options that meet the performance requirements are acceptable.

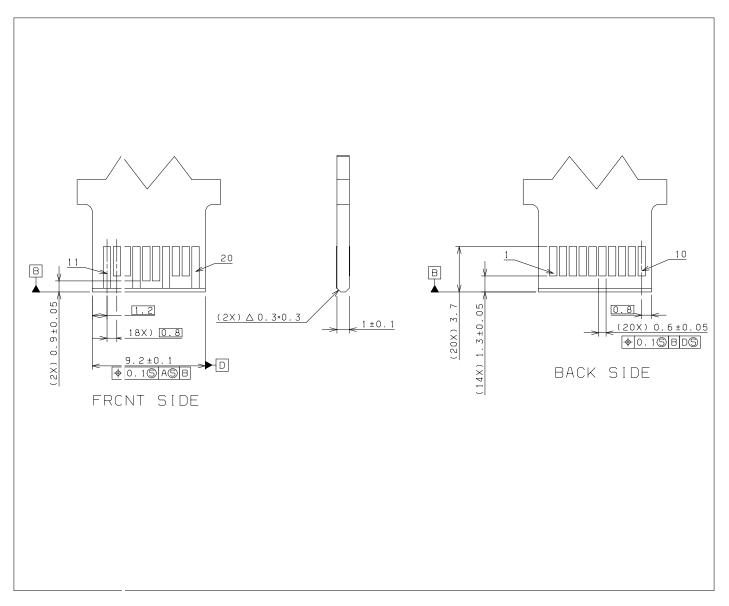


Figure 2. Recommended Pattern Layout for SFP with OM Printed Circuit Board

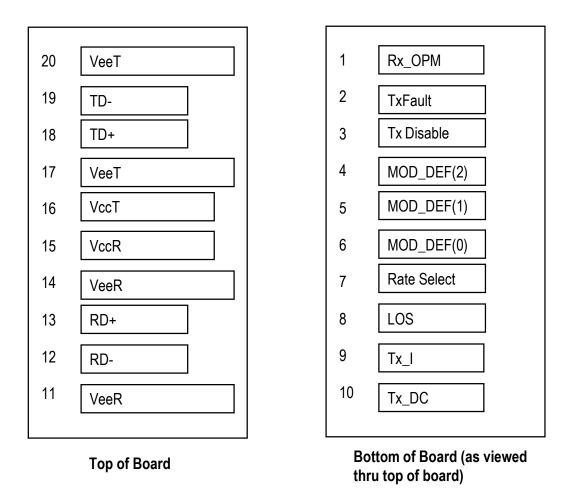


Figure 3. SFP with OM Transceiver Electrical Pad Layout

A3. Host Board Layout

A typical host board mechanical layout for attaching the SFP with OM Connector and Cage System is shown in Figures 4A and 4B.

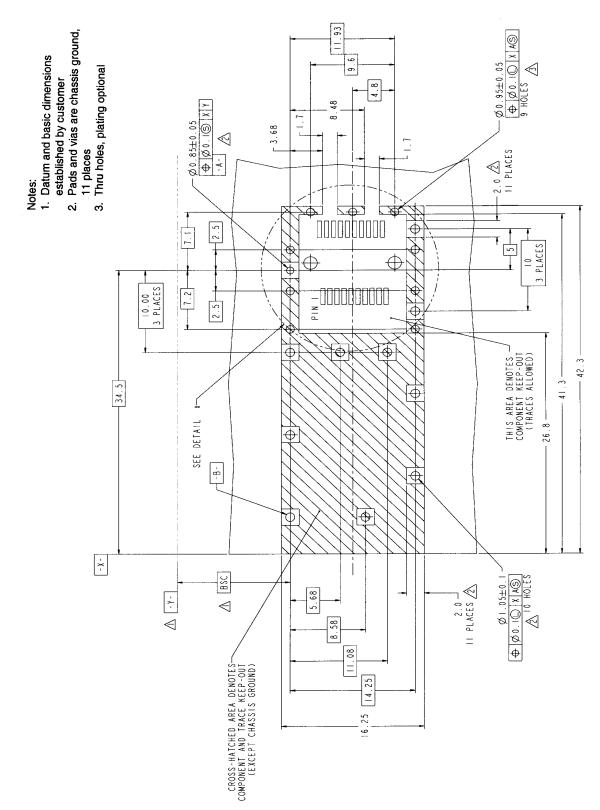


Figure 4A. SFP with OM Host Board Mechanical Layout

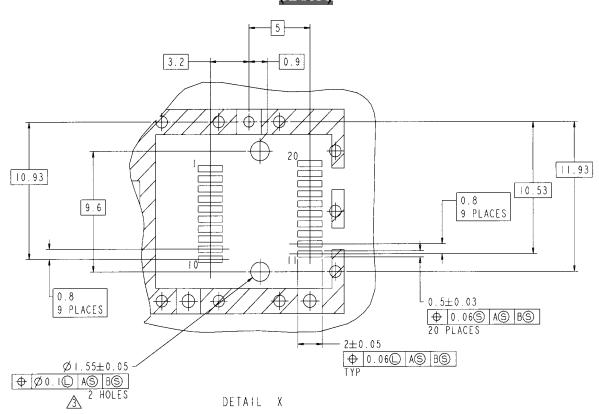


Figure 4B. SFP with OM Host Board Mechanical Layout (Cont.)

A4. Insertion, Extraction and Retention Forces for SFP with OM Transceivers

The requirement for the various functional forces and the durability cycles are specified in Table 2.

Measurement	Minimum	Maximum	Units	Comments
SFP with OM transceiver insertion	0	40	Newtons	
SFP with OM transceiver extraction	0	11.5	Newtons	
SFP with OM transceiver retention	90	170	Newtons	No damage to transceiver below 90N
Cage retention (Latch strength)	180	N/A	Newtons	No damage to latch below 180N
Cage kickout spring force	11.5	22	Newtons	
Insertion / removal cycles, connector/cage	100	N/A	cycles	
Insertion / removal cycles, SFP with OM transceiver	50	N/A	cycles	

Table 2. Insertion, Extraction, and Retention Forces

A5. Labeling of SFP with OM Transceivers

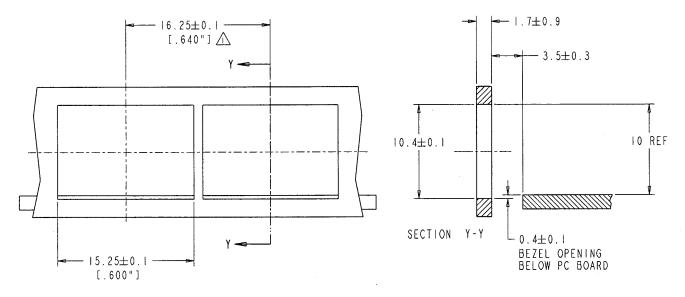
Color coding requirements for optical SFP with OM transceivers are specified in Figure 1B.

Each SFP with OM transceiver should be clearly labeled. The complete labeling need not be visible when the SFP with OM transceiver is installed. Labeling should include appropriate manufacturing and part number identification, appropriate regulatory compliance labeling, and a clear specification of the external port characteristics. The external port characteristic label may include such information as optical wavelength, required fiber characteristics, operating data rate, interface standards supported, and link length supported.

A6. Bezel Design for Systems Using SFP with OM Transceivers

Host enclosures that use SFP with OM devices should provide appropriate clearances between the SFP with OM transceivers to allow insertion and extraction without the use of special tools and a bezel enclosure with sufficient mechanical strength. For most systems a nominal centerline to centerline spacing of 16.25mm (0.640") is sufficient. See Figure 5 for the recommended bezel design. For double-sided board mounting, a printed circuit board thickness of 3.0mm (0.118") is required.

The SFP with OM transceiver insertion slot should be clear of nearby moldings and covers that might block convenient access to the latching mechanisms, the SFP with OM transceiver, or the cables connected to the SFP with OM transceiver.



NOTES:

- \bigtriangleup MINIMUM PITCH ILLUSTRATED, ENGLISH DIMENSIONS ARE FOR REFERENCE ONLY
- 2. NOT RECOMMENDED FOR PCI EXPANSION CARD APPLICATIONS

Figure 5. Recommended Bezel Design

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A7. SFP with OM Electrical Connector Mechanical Specifications

The SFP with OM Connector is a 20-contact, right angle surface mount connector. It is described in Table 3 and Figure 6. The plating on the contacts is specified as follows:

- Contact area: 0.38 micrometers minimum hard gold over 2.54 micrometers minimum thick nickel
- Solder terminal area: gold flash or 2.54 micrometers tin lead plating over 2.54 minimum thick nickel.

Designator	Dimension (mm)	Tolerance (mm)	Comments
A	9.4	± 0.08	Connector card slot width
В	1.4	± 0.05	Guide pin diameter
С	11.2	Maximum	Connector width
D	9.2	Maximum	Connector length
E	3.5	Reference	Distance from centerline of connector to outer contact
F	3.9	Reference	Distance from centerline of connector to outer contact
G	1.35	Maximum	Connector card slot height
Н	2.6	Minimum	Height from bottom of connector to bottom of card slot
J	9.6	TP	Distance between guide pins
K	0.9	Reference	Diamond guide pin width
L	1.4	± 0.05	Diamond guide pin length
М	5.4	Maximum	Connector height
N	0.8	Reference	Length of solder leads past housing, front & rear
Р	6.0	Minimum	Depth of card slot from front face of housing
Q	3.0	Maximum	Depth of contact point from front face of connector
R	0.7	± 0.1	Size of chamfer on top face of connector
S	0.3	Reference	Distance boss extends past front face of connector
Т	1.0	Minimum	Size of chamfer at entry of card slot, all around
U	4.5	Reference	Length from centerline of guide posts to end of solder lead

Table 3. SFP with OM Transceiver Connector Dimensions

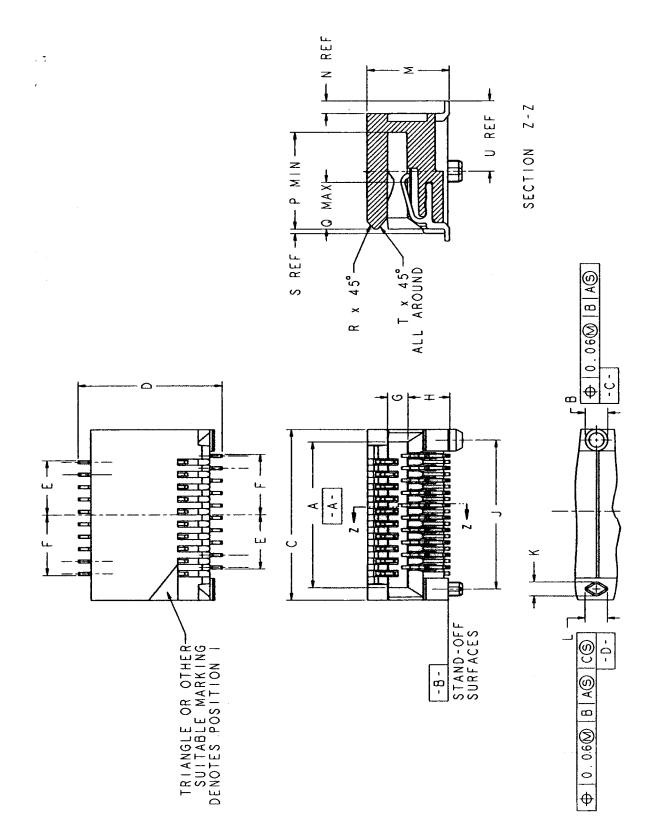


Figure 6. SFP with OM Transceiver Connector Illustration

A8. SFP with OM Cage Assembly Dimensions

The SFP with OM Cage Assembly consists of two components: a lower cage that is soldered to the host board and a top cage that is assembled to the lower cage after soldering. A reference drawing describing the SFP with OM Cage Assembly is provided in Table 4 and Figures 7A and 7B. The cage material is copper alloy and plating options are:

- Tin-lead plate 2.54 micrometers minimum over copper flash
- Tin plate 2.54 micrometers minimum over 0.76 micrometers minimum nickel

Table 4. Dimension Table for Drawing of SFP with OM Cage Assembly

Designator	Dimension (mm)	Tolerance (mm)	Comments	
A	48.8	Maximum	Overall length	
В	8.3	Maximum	Length from inside top of cage to latch	
С	14.0	± 0.1	Inside width of cage	
D	14.25	Basic	Distance between solderleg centerlines on side of cage	
E	0.249	± 0.025	Thickness of solderleg	
F	9.0	Basic	Distance between vent holes along length	
G	11.8	Basic	Distance from front of cage to beginning of center vent hole row	
Н	7.9	Basic	Distance between vent holes across the width of the cage	
J	2.0	± 0.1	Diameter of vent holes	
K	16.5	Basic	Distance from front of cage to solderleg	
L	10.0	Basic	Distance between chassis ground solderlegs along side	
М	0.6	± 0.1	Width of EMI pins	
N	0.7	± 0.1	Width of all chassis ground solderlegs	
Р	2.0	Maximum	Width of solderleg shoulder	
Q	1.25	Maximum	Length of solderleg	
R	3.95	Basic	Distance from centerline of cage to centerline of chassis ground solderleg	
S	1.45	Basic	 Distance from centerline of cage to centerline of chassis ground solderleg 	
Т	1.45	Basic	Distance from centerline of cage to centerline of chassis ground solderleg	
U	4.8	Basic	Distance from centerline of cage to centerline of EMI pins	
V	0.5	± 0.05	Width of EMI pins on top cage	
W	9.2	± 0.15	Distance from inside top of cage to inside bottom surface of front section of cage assembly	
Х	9.8	Maximum	Maximum height of cage assembly from host board	
Z	10.0	Basic	Distance between chassis ground solderlegs along side	
AA	11.5	Basic	Distance from front of cage to solderleg	
AB	7.5	Minimum	Length of 9.2 (W) dimension from front of cage	
AC	15.0	Maximum	Maximum width of cage assembly	
AD	13.9	Minimum	Minimum width of inside of cage	
AE	8.95	± 0.15	Height of inside of cage assembly	
AF	1.0	Minimum	Height of clearance slots	
AG	2.4	Basic	Distance of clearance slots from cage centerline	

Table 4. Dimension Table for Drawing of SFP with OM Cage Assembly (Cont.)

Designator	Dimension (mm)	Tolerance (mm)	Comments
AH	3.0	± 0.1	Width of clearance slots
AJ	2.35	± 0.1	Distance from front of cage to latch opening
AK	2.8	± 0.1	Length of latch opening
AL	0.5	Minimum	Height of latch lead-in
AM	45.6	Maximum	Distance from front of cage to kickout spring
AN	35.0	Maximum	Distance from front of cage to end of cage floor
AP	0.7	± 0.1	Width of solderlegs that extend from floor of cage
AQ	5.1	Maximum	Width of latch
AR	3.0	± 0.05 Width of latch opening	
AS	16.3	Basic	Front of cage to beginning of outer vent hole rows
AT	0.65	Maximum	Inside radius of cage, four places
AU	5.8	Minimum	Distance between panel ground spring supports
AV	12.7	Maximum	Length of plug extending outside of the cage
		recommended	
AW	15.75	Maximum	Width of plug extending outside of the cage
AX	10.9	Maximum	Height of plug extending outside of the cage

A9. Dust / EMI Cover

The order to prevent contamination of the internal components and to optimize EMI performance, it is recommended that a Dust/EMI Plug be inserted into cage assemblies when no transceiver is present. The maximum dimensions of the Dust/EMI Cover are listed in Table 4 and the maximum size is illustrated in Figure 7A. The Dust/EMI Cover shall exert a maximum force of 4.0 Newtons per side to the inside surfaces of the cage. This force shall be measured as the force/side required to compress the Dust/EMI Cover's compliant feature(s) to the maximum dimensions listed in Table 4 (Illustrated in Figure 7A).

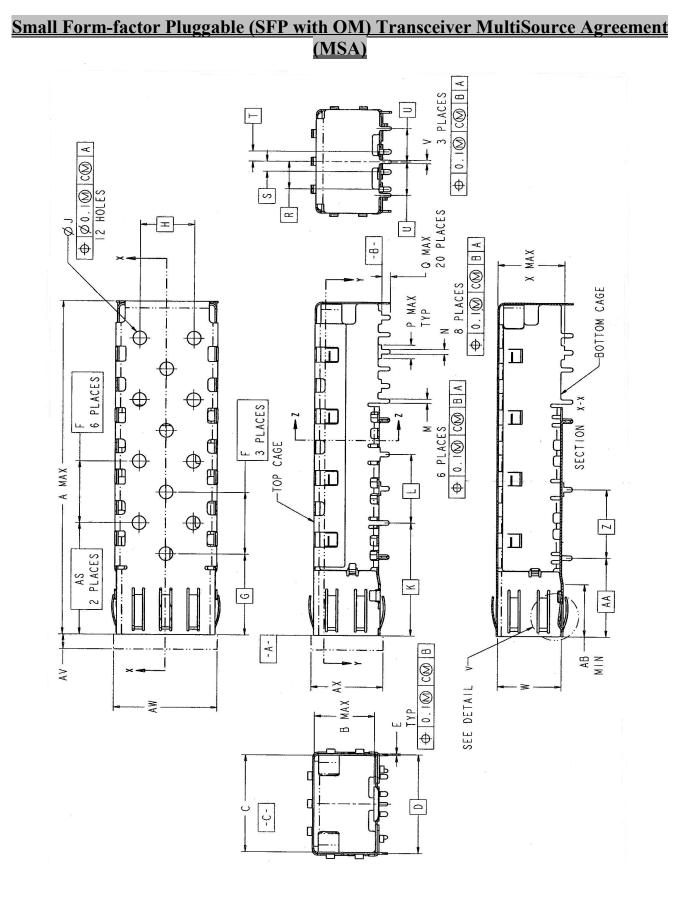
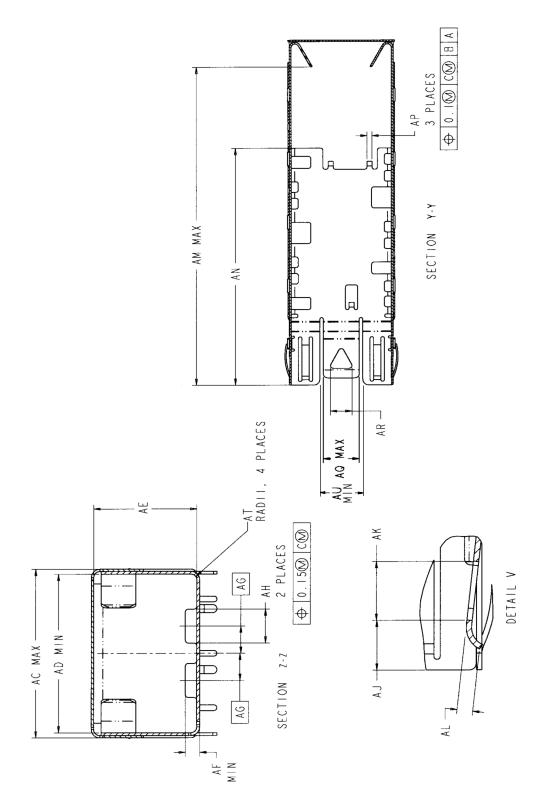


Figure 7A. SFP with OM Cage Assembly

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Appendix B. Electrical Interface

B1. Introduction

This annex contains pin definition data for the small form-factor pluggable (SFP with OM) transceiver. The pin definition data is specific to gigabit rate datacom applications such as Fibre Channel and Gigabit Ethernet. It is expected that different pin definitions will be developed for SONET/ATM and lower data rate datacom applications.

B2. Pin Definitions

Figure 1 below shows the pin names and numbering for the connector block on the host board. The diagram is in the same relative orientation as the host board layout (see Appendix A, Figure 4.). As mentioned, this pinout only applies to gigabit rate datacom applications. The pin functions are defined in Table 1 and the accompanying notes. Figure 2A shows the recommended power supply filtering network. Figure 2B shows an example of a complete SFP with OM host board schematic with connections to SerDes and protocol ICs. For EMI protection the signals to the 20-pin connector should be shut off when the transceiver is removed. Standard board layout practices such as connections to Vcc and GND with Vias, use of short- and equal-length differential signal lines, use of microstrip-lines and 50Ω terminations are recommended. Chassis grounds and external electromagnetic interference shields should not be attached to circuit ground.

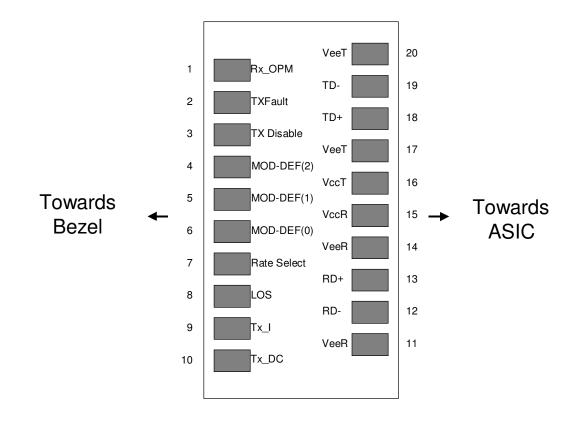


Figure 1. Diagram of Host Board Connector Block Pin Numbers and Names

Pin Num.	Name	Function	Plug Seq.	Notes
1	Rx_OPM	Voltage corresponding on Modulated Received Optical Power	3	Note 1
2	Tx_Fault	Transmitter Fault Indication	3	Note 2
3	Tx_Disable	Transmitter Disable	3	Note 3 Module disables on high or open
4	MOD_DEF2	Module Definition 2	3	Note 4, 2 wire serial ID interface
5	MOD_DEF1	Module Definition 1	3	Note 4, 2 wire serial ID interface
6	MOD_DEF0	Module Definition 0	3	Note 4, Grounded in Module
7	Rate Select	Select between full or reduced receiver bandwidth.	3	Note 5 Low or Open – reduced bandwidth, High– full bandwidth
7	Tx Feedback Disable (Optional)	Select between Tx Open or Closed loop. Open loop used for transceiver margining (Optional)	3	Note 5 Low or Open – Normal operation High- Tx Open Loop
8	Rx_LOS	Loss of Signal	3	Note 6
9	Tx_I	Voltage corresponding to Current through Laser	3	Note 8
10	Tx_DC	Voltage corresponding to Power transmitted by Laser	3	Note 9
11	VeeR	Receiver Ground	1	Note 7
12	RD-	Inv. Received Data Out	3	Note 10
13	RD+	Received Data Out	3	Note 10
14	VeeR	Receiver Ground	1	Note 7
15	VccR	Receiver Power	2	3.3 ± 5%, Note 11
16	VccT	Transmitter Power	2	3.3 ± 5%, Note 11
17	VeeT	Transmitter Ground	1	Note 7
18	TD+	Transmit Data In	3	Note 12
19	TD-	Inv. Transmit Data In	3	Note 12
20	VeeT	Transmitter Ground	1	Note 7

Table 1. Pin Function Definitions

Plug Seq.: Pin engagement sequence during hot plugging.

 Rx_OPM is an analog voltage output signal that corresponds to the amplitude of the modulated received signal. The output ranges from 0 to VccR - 0.3V. The actual uW received is determined by measuring the voltage on Rx_OPM(V) and reading Rx_OPM(4), Rx_OPM(3), Rx_OPM(2), Rx_OPM(1) and Rx_OPM(0) values stored in the EEPROM.

 $Rx_OPM(uW) = Rx_OPM(4)^*Rx_OPM(V)^4 + Rx_OPM(3)^*Rx_OPM(V)^3 + Rx_OPM(2)^*Rx_OPM(V)^2 + Rx_OPM(1)^*Rx_OPM(V) + Rx_OPM(0)$

SW P-P Optical Power (OMA) Input Range:	31uW to 650uW (-17dBm to –4dBm, ER=9dB)
LW P-P Optical Power (OMA) Input Range:	15uW to 430uW (-20dBm to -5.5dBm, ER=9dB)

Accuracy is +/- 12% uW for both SW and LW lasers across temperature and voltage range

Table 1 Notes (Cont.)

- 2) Tx_Fault is an open collector/drain output, which should be pulled up with a 4.7K 10KΩ resistor on the host board. Pull up voltage between 2.0V and VccT, R+0.3V. When high, output indicates a laser fault of some kind. Low indicates normal operation. In the low state, the output will be pulled to < 0.8V.</p>
- 3) Tx_Disable is an input that is used to shut down the transmitter optical output. It is pulled up within the module with a $4.7 10 \text{ K}\Omega$ resistor. Its states are:

Low (0 – 0.8V):	Transmitter on
(>0.8, < 2.0V):	Undefined
High (2.0 – 3.465V):	Transmitter Disabled
Open:	Transmitter Disabled

 Mod-Def 0,1,2. These are the module definition pins. They should be pulled up with a 4.7K – 10KΩ resistor on the host board. The pull-up voltage shall be VccT or VccR (see Section IV for further details).

Mod-Def 0 is grounded by the module to indicate that the module is present Mod-Def 1 is the clock line of two wire serial interface for serial ID Mod-Def 2 is the data line of two wire serial interface for serial ID

5) This is an optional input used to control the receiver bandwidth for compatibility with multiple data rates (most likely Fibre Channel 1x and 2x Rates). If implemented, the input will be internally pulled down with > $30k\Omega$ resistor. The input states are:

Low (0-0.8V):	Reduced Bandwidth
(>0.8 , < 2.0V):	Undefined
High (2.0 – 3.465V):	Full Bandwidth
Open:	Reduced Bandwidth

Optional Implementation for Pin 7

This is an optional input used to margin the transmitter. Laser eye safety is closed loop mode. If implemented, the input will be internally pulled down with > $30k\Omega$ resistor. The input states are:

Low (0-0.8V):	Normal Operation
(>0.8 , < 2.0V):	Undefined
High (2.0 – 3.465V):	Tx Open loop mode with constant current through the laser,
	laser margining mode
Open:	Normal Operation

- 6) Rx_LOS (Loss of Signal) is an open collector/drain output, which should be pulled up with a 4.7K 10KΩ resistor. Pull up voltage between 2.0V and VccT, R+0.3V. When high, this output indicates the received optical power is below the worst-case receiver sensitivity (as defined by the standard in use). Low indicates normal operation. In the low state, the output will be pulled to < 0.8V.</p>
- 7) VeeR and VeeT may be internally connected within the SFP with OM module.
- 8) Tx_I is an analog voltage output signal that corresponds to the current passing through the laser diode. The output ranges 0 to VccT 0.3V. The actual mA received is determined with the following equation by measuring the voltage on Tx_I(V) and reading Tx_I(Slope) and Tx_I(Offset) values stored in the EEPROM.

$$Tx_l(mA) = Tx_l(Slope) * Tx_l(V) + Tx_l(Offset)$$

Tx_I range (i.e 0 to 40mA) is selected by the transceiver manufacture to cover the Tx_DC range defined below. The accuracy of Tx_I is +/- 10% across the temperature and voltage range.

9) Tx_DC is an analog voltage output signal that corresponds to the transmitted signal strength. The output ranges from 0 to VccT - 0.3V. The actual uW received is determined with the following equation by measuring the voltage on Tx_DC(V) and reading Tx_DC(Slope) and Tx_DC(Offset) values stored in the EEPROM.

$$Tx_DC(uW) = Tx_DC(Slope) * Tx_DC(V) + Tx_DC(Offset)$$

The Tx_DC range is 63uW to 398uW (-12dBm to -4dBm) The accuracy is +/-12%uW or +/- 0.5dB across the temperature and voltage range

- 10) RD-/+: These are the differential receiver outputs. They are AC coupled 100 Ω differential lines which should be terminated with 100 Ω (differential) at the user SERDES. The AC coupling is done inside the module and is thus not required on the host board. The voltage swing on these lines will be between 370 and 2000 mV differential (185 1000 mV single ended) when properly terminated.
- 11) VccR and VccT are the receiver and transmitter power supplies. They are defined as 3.3V ±5% at the SFP with OM connector pin. Maximum supply current is 300 mA. Recommended host board power supply filtering is shown below. Inductors with DC resistance of less than 1Ω should be used in order to maintain the required voltage at the SFP with OM input pin with 3.3V supply voltage. When the recommended supply filtering network is used, hot plugging of the SFP with OM transceiver module will result in an inrush current of no more than 30 mA greater than the steady state value. VccR and VccT may be internally connected within the SFP with OM transceiver module.
- 12) TD-/+: These are the differential transmitter inputs. They are AC-coupled, differential lines with 100Ω differential termination inside the module. The AC coupling is done inside the module and is thus not required on the host board. The inputs will accept differential swings of 500 2400 mV (250 1200 mV single-ended), though it is recommended that values between 500 and 1200 mV differential (250 600 mV single-ended) be used for best EMI performance.

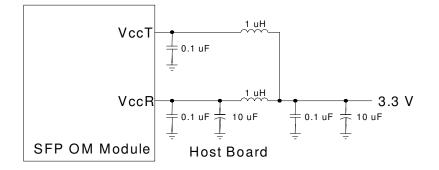


Figure 2A. Recommended Host Board Supply Filtering Network

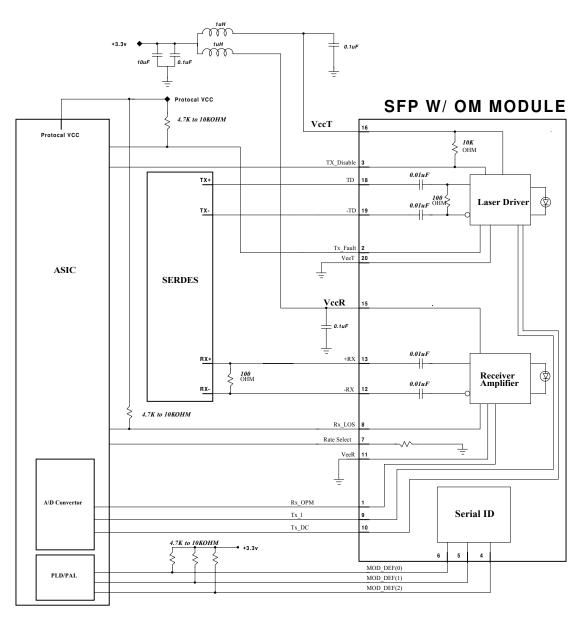


Figure 2B. Example SFP with OM Host Board Schematic

B3. Timing Requirements of Control and Status I/O

The timing requirements of the control and status lines are drawn largely from the GBIC standard at the time of writing. They are summarized in Table 2 below:

Parameter	Symbol	Min	Max	Unit	Condition
Tx_Disable Assert Time	t_off		10	μs	Time from rising edge of Tx_Disable to when the optical output falls below 10% of nominal
Tx_Disable Negate Time	t_on		1	ms	Time from falling edge of Tx_Disable to when the modulated optical output rises above 90% of nominal
Time to initialize, including reset of Tx_Fault	t_init		300	ms	From power on or negation of Tx_Fault using Tx_Disable
Tx_Fault Assert Time	t_fault		100	μs	Time from fault to TX fault on.
Tx_Disable to reset	t_reset	10		μs	Time Tx_Disable must be held high to reset TX_fault
Rx_LOS Assert Time	t_loss_on		100	μs	Time from Rx_LOS state to Rx_LOS assert
Rx_LOS Deassert Time	t_loss_off		100	μs	Time from non-Rx_LOS state to Rx_LOS deassert
Rate-Select Change Time	t_ratesel		10	μs	Time from rising or falling edge of Rate Select input until receiver bandwidth is in conformance with appropriate specification.
Serial ID Clock Rate	f_serial_clock		100	kHz	

Table 2. Timing Requirements of Control and Status I/0

SFP with OM transceiver power on initialization procedure, Tx_Disable negated.

During power on of the SFP with OM transceiver, Tx_Fault, if implemented, may be asserted (High) as soon as power supply voltages are within specification. For transceiver initialization with Tx_Disable negated, Tx_Fault shall be negated when the transmitter safety circuitry, if implemented, has detected that the transmitter is operating in its normal state. If a transmitter fault has not occurred, Tx_Fault shall be negated within a period t_init from the time that V_{CC}T exceeds the specified minimum operating voltage (see Table 2). If Tx_Fault remains asserted beyond the period t_init, the host may assume that a transmission fault has been detected by the transceiver.

SFP with OM transceiver power on initialization procedure, Tx_Disable negated (Cont.)

If no transmitter safety circuitry is implemented, the Tx_Fault signal may be tied to its negated state.

The power-on initialization timing for a transceiver with Tx_Disable negated is shown in Figure 3.

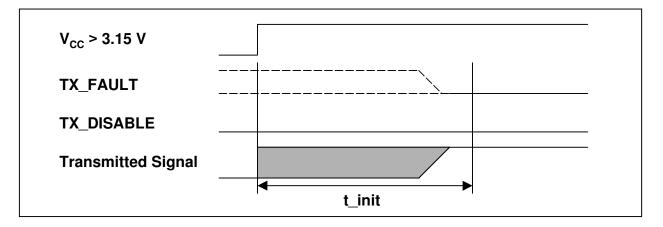


Figure 3. Power on initialization of SFP with OM transceiver, Tx_Disable negated

SFP with OM transceiver power on initialization procedure, Tx_Disable asserted.

For SFP with OM transceiver power on initialization with Tx_Disable asserted, the state of Tx_Fault is not defined while Tx_Disable is asserted. After Tx_Disable is negated, Tx_Fault may be asserted while safety circuit initialization is performed. Tx_Fault shall be negated when the transmitter safety circuitry, if implemented, has detected that the transmitter is operating in its normal state. If a transmitter fault has not occurred, Tx_Fault shall be negated within a period t_init from the time that Tx_Disable is negated. If Tx_Fault remains asserted beyond the period t_init, the host may assume that a transmission fault has been detected by the transceiver.

If no transmitter safety circuitry is implemented, the Tx_Fault signal may be tied to its negated state. The power-on initialization timing for a SFP with OM transceiver with Tx_Disable asserted is shown in Figure 4.

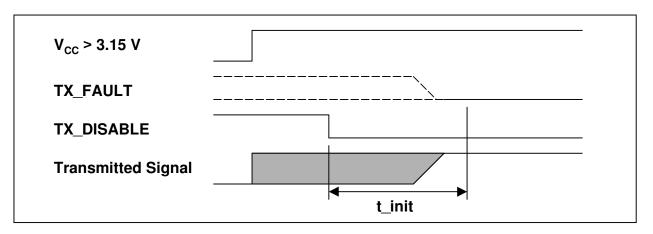
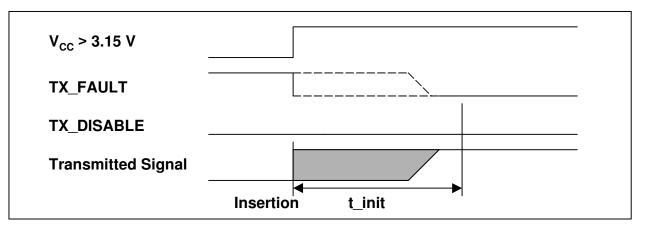
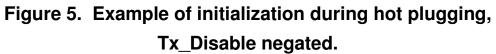


Figure 4. Power on initialization of SFP with OM, Tx_Disable asserted Initialization during hot plugging of SFP with OM TRANSCEIVER.

When a transceiver is not installed, Tx_Fault is held to the asserted state by the pull up circuits on the host. As the SFP with OM transceiver is installed, contact is made with the ground, voltage, and signal contacts in the specified order. After the SFP with OM has determined that $V_{CC}T$ has reached the specified value, the power on initialization takes place as described in the above sections. An example of initialization during hot plugging is provided in Figure 5.





SFP with OM transmitter management

The timing requirements for the management of optical outputs from the SFP with OM transceiver using the Tx_Disable signal are shown in Figure 6. Note that the t on time refers to the maximum delay until the modulated optical signal reaches 90% of the final value, not just the average optical power.

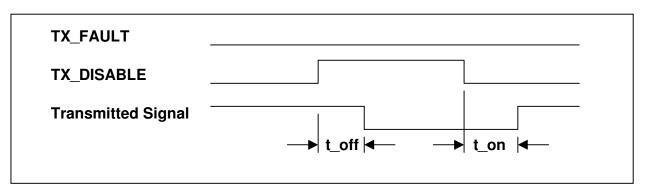
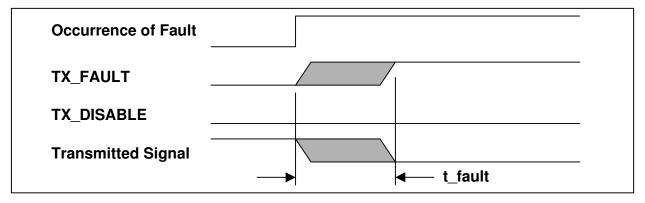


Figure 6. SFP with OM Tx_Disable timing during normal operation.

SFP with OM transceiver fault detection and presentation

Tx_Fault shall be implemented by those module definitions of SFP with OM transceiver supporting safety circuitry. If Tx_Fault is not implemented, the signal shall be held to the low state by the SFP with OM transceiver.





SFP with OM transceiver fault recovery

The detection of a safety-related transmitter fault condition presented by Tx_Fault shall be latched. The following protocol may be used to reset the latch in case the transmitter fault condition is transient. To reset the fault condition and associated detection circuitry, Tx_Disable shall be asserted for a minimum of t_reset. Tx_Disable shall then be negated. In less than the maximum value of t_init the optical transmitter will correctly reinitialize the laser circuits, negate Tx_Fault, and begin normal operation if the fault condition is no longer present. If a fault condition is detected during the reinitialization, Tx_Fault shall again be asserted, the fault condition again latched, and the optical transmitter circuitry will again be disabled until the next time a reset protocol is attempted. The manufacturer of the SFP with OM shall ensure that the optical power emitted from an open connector or fiber is compliant with IEC825-1 and CDRH during all reset attempts, during normal operation or upon the occurrence

SFP with OM transceiver fault recovery (Cont.)

of reasonable single fault conditions. The SFP with OM transceiver may require internal protective circuitry to prevent the frequent assertion of the Tx_Disable signal from generating frequent pulses of energy that violate the safety requirements. The timing for successful recovery from a transient safety fault condition is shown in Figure 8.

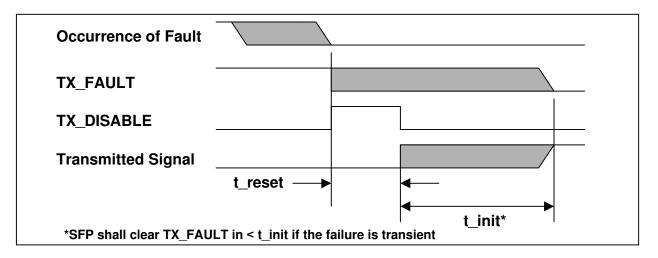


Figure 8. Successful recovery from transient safety fault condition

An example of an unsuccessful recovery, where the fault condition was not transient, is shown in Figure 9.

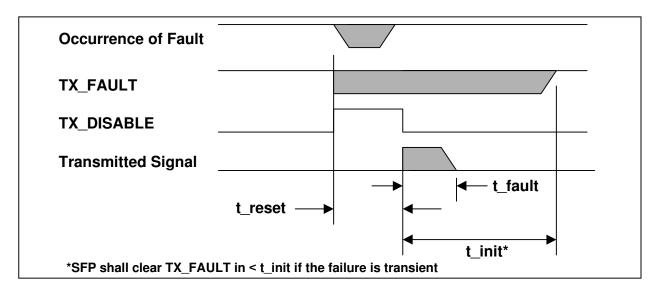


Figure 9. Unsuccessful recovery from safety fault condition

SFP with OM transceiver loss of signal indication

The Rx_LOS signal is intended as a preliminary indication to the system in which the SFP with OM transceiver is installed that the link signals are likely to be outside the required values for proper operation. Such indications typically point to non-installed cables, broken cables, or a disabled, failing or powered off transmitter at the far end of the cable. Additional indications are provided by the system in which the SFP with OM transceiver is installed to verify that the information being transmitted is valid, correctly encoded, and in the correct format. Such additional indications are outside the scope of the SFP with OM TRANSCEIVER MSA.

The timing of the Rx_LOS function is specified in Figure 10.

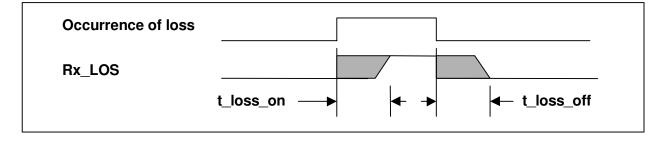


Figure 10. Timing of Rx_LOS detection

B4. Module Definition Interface and Data Field Description

The definition of the MOD_DEF function is drawn largely from the GBIC standard with some small, but backwards compatible, changes to the fields or allowed values to reflect the latest standards and expectations for these transceivers. In some cases, this backward compatibility approach results in the possibility of illegal combinations (such as defining an SFP with OM module with SC optical connectors). Some locations previously reserved in the GBIC serial identification have now been defined.

It should be noted that only the serial module definition and the basic MOD_DEF(0) indication of module present are implemented. The use of MOD_DEF lines as static codes for module definition as done with GBIC are not implemented.

Overview

The SFP with OM Serial ID provides access to sophisticated identification information that describes the transceiver's capabilities, standard interfaces, manufacturer, and other information. The serial interface uses the 2-wire serial CMOS E²PROM protocol defined for the ATMEL AT24C01A/02/04 family of components.

When the serial protocol is activated, the host generates the serial clock signal [SCL, MOD_DEF(1)]. The positive edge clocks data into those segments of the E²PROM that are not write-protected within the SFP with OM transceiver. The negative edge clocks data from the SFP with OM transceiver.

The serial data signal [SDA, MOD_DEF(2)] is bi-directional for serial data transfer. The host uses SDA in conjunction with SCL to mark the start and end of serial protocol activation. The memories are organized as a series of 8-bit data words that can be addressed individually or sequentially.

This section defines the information structures that are obtained from the SFP with OM transceiver via the Serial ID.

A SFP with OM transceiver shall meet the electrical and optical requirements, including amplitude, eye diagram, jitter, and other parameters, specified for the standards with which the transceiver claims compliance.

Serial information definition

The 2-wire serial CMOS E^2 PROM provides sequential or random access to 8 bit parameters, addressed from 0000h to the maximum address of the memory. The address select pins for the serial CMOS E^2 PROM shall be set to zero (fixed at the V_{IL} low level). The fields specified by this section shall not be written by the host in which it is installed. The SFP with OM transceiver may enforce this by using the write protect features of the CMOS E^2 PROM.

Serial information definition (Cont.)

The word address is transmitted with the high order bit transmitted first. The protocol for the 2-wire serial interface sequentially transmits one or more 8-bit bytes, with the data byte addressed by the lowest word address transmitted first. In each data byte, the high order bit (bit 7 in the accompanying tables) is transmitted first.

Numeric fields are expressed in binary, with the high order byte being transferred first and the high order bit of each byte being transferred first. Numeric fields are padded on the left with binary zero values.

Character strings are ordered with the first character to be displayed located in the lowest word address of the string. Each character shall be coded as a US-ASCII character as defined by ISO 8859-1, with the high order bit transmitted first. All character strings will be padded on the right with ASCII spaces (20h) to fill empty bytes.

All bits of reserved fields shall be set to zero until future definitions require their use.

A minimum of 96 bytes shall be readable by the serial identification process.

The maximum clock rate of the serial interface shall be 100 KHz.

The following tables define the contents of the serial CMOS E²PROM. The first table is a summary of all the data fields in the serial ID chip. The remaining tables contain detailed descriptions of the individual data fields.

Data Address	Field Size (Bytes)	Name of field	Description of field			
	BASE ID FIELDS					
0	1	Identifier	Type of serial transceiver (see Table 3.2)			
1	1	Ext. Identifier	Extended identifier of type of serial transceiver			
2	1	Connector	Code for connector type (see Table 3.3)			
3-10	8	Transceiver	Code for electronic compatibility or optical compatibility (see Table 3.4)			
11	1	Encoding	Code for serial encoding algorithm (see Table 3.5)			
12	1	BR, Nominal	Nominal bit rate, units of 100 MBits/sec.			
13	1	Reserved				
14	1	Length(9m) - km	Link length supported for 9/125 mm fiber, units of km			
15	1	Length (9m)	Link length supported for 9/125 mm fiber, units of 100 m			
16	1	Length (50m)	Link length supported for 50/125 mm fiber, units of 10 m			
17	1	Length (62.5m)	Link length supported for 62.5/125 mm fiber, units of 10 m			
18	1	Length (Copper)	Link length supported for copper, units of meters			
19	1	Reserved				
20-35	16	Vendor name	SFP with OM transceiver vendor name (ASCII)			
36	1	Reserved				
37-39	3	Vendor OUI	SFP with OM transceiver vendor IEEE company ID			
40-55	16	Vendor PN	Part number provided by SFP with OM transceiver vendor (ASCII)			
56-59	4	Vendor rev	Revision level for part number provided by vendor (ASCII)			
60-62	3	Reserved				
63	1	CC_BASE	Check code for Base ID Fields (addresses 0 to 62)			
			EXTENDED ID FIELDS			
64-65	2	Options	Indicates which optional SFP with OM signals are implemented (see Table 3.6)			
66	1	BR, max	Upper bit rate margin, units of %			
67	1	BR, min	Lower bit rate margin, units of %			
68-83	16	Vendor SN	Serial number provided by vendor (ASCII)			
84-91	8	Date code	Vendor's manufacturing date code (see Table 3.7)			
92-94	3	Reserved				
95	1	CC_EXT	Check code for the Extended ID Fields (addresses 64 to 94)			
	OM OUTPUT CALIBRATION ID FIELDS (see Table 3.8)					
96-99	4	Rx_OPM(4)	Single Precision Floating Point Calibration Data, Rx Optical Power, Bit 7 of byte 96 is Most Significant bit, bit 0 of byte 99 is Least Significant bit.			
100-103	4	Rx_OPM(3)	Single Precision Floating Point Calibration Data, Rx Optical Power Bit 7 of byte 100 is Most Significant bit, bit 0 of byte 103 is Least Significant bit.			

Table 3.1. Serial ID: Data Fields

Data Address	Field Size (Bytes)	Name of field	Description of field	
104-107	4	Rx_OPM(2)	Single Precision Floating Point Calibration Data, Rx Optical Power. Bit 7 of byte 104 is Most Significant bit, bit 0 of byte 107 is Least Significant bit.	
108-111	4	Rx_OPM(1)	Single Precision Floating Point Calibration Data, Rx Optical Power. Bit 7 of byte 108 is Most Significant bit, bit 0 of byte 111 is Least Significant bit.	
112-115	4	Rx_OPM(0)	Single Precision Floating Point Calibration Data, Rx Optical Power. Bit 7 of byte 112 is Most Significant bit, bit 0 of byte 115 is Least Significant bit.	
116-119	4	Tx_I(Slope)	Single Precision Floating Point Calibration Data, Laser Transimit Current. Bit 7 of byte 116 is Most Significant bit, bit 0 of byte 119 is Least Significant bit.	
120-123	4	Tx_DC(Slope)	Single Precision Floating Point Calibration Data, Laser Transmit Power. Bit 7 of byte 120 is Most Significant bit, bit 0 of byte 123 is Least Significant bit.	
124-125	2	Tx_I(Offset)	Fixed Decimal Calibration Data with fixed 10 ⁶ multiplier, Laser Transmit Current. Bit 7 of byte 124 is Most Significant bit, bit 0 of byte 125 is Least Significant bit.	
126-127	2	Tx_DC(Offset)	Fixed Decimal Calibration Data with fixed 10 ⁶ multiplier, Laser Transmit Power. Bit 7 of byte 126 is Most Significant bit, bit 0 of byte 127 is Least Significant bit.	
VENDOR SPECIFIC ID FIELDS				
128-255	128	Customer Writeable Area	Atmel AT34C02 or Equivalent	
256-511	256	Reserved		
512-n			Vendor specific	

Identifier

The identifier value specifies the physical device described by the serial information. This value shall be included in the serial data. The defined identifier values are shown in Table 3.2.

 Table 3.2. Identifier Values

Value	Description of Physical Device
00h	Unknown or unspecified
01h	GBIC
02h	Module/connector soldered to motherboard
03h	SFP Transceiver
04h	SFP with OM Transceiver
05-7Fh	Reserved
80-FFh	Vendor specific

Extended Identifier

The field should be set to 04h for all SFP with OM modules indicating serial ID module definition.

Connector

The Connector value indicates the external connector provided on the interface. This value shall be included in the serial data. The defined connector values are shown in Table 3.3. Note that 01h - 05h are not SFP with OM compatible, and are included for compatibility with GBIC standards

Value	Description of Connector
00h	Unknown or unspecified
01h	SC
02h	Fibre Channel Style 1 copper connector
03h	Fibre Channel Style 2 copper connector
04h	BNC/TNC
05h	Fibre Channel coaxial headers
06h	FiberJack
07h	LC
08h	MT-RJ
09h	MU
0Ah	SG
0Bh	Optical pigtail
0C-1Fh	Reserved
20h	HSSDC II
21h	Copper Pigtail
22h-7Fh	Reserved
80-FFh	Vendor specific

TABLE 3.3. Connector Values

Transceiver

The following bit significant indicators define the electronic or optical interfaces that are supported by the SFP with OM transceiver. At least one bit shall be set in this field. For Fibre Channel SFP with OMs, the Fibre Channel speed, transmission media, transmitter technology, and distance capability shall all be indicated.

Data Addr	Bit ¹	Description of transceiver	Data Addr	Bit ¹	Description of transceiver	
Reserved Standard Compliance Codes				Fibre Channel link length		
3	7-0	0 Reserved		7	very long distance (V)	
4	7-4	Reserved	7	6	short distance (S)	
	S	ONET Compliance Codes	7	5	intermediate distance (I)	
4	3	Reserved	7	4	long distance (L)	
4	2	OC 48, long reach	Fib	ore Ch	annel transmitter technology	
4	1	OC 48, intermediate reach	7	3-2	Reserved	
4	0	OC 48 short reach	7	1	Longwave laser (LC)	
5	7	Reserved	7	0	Electrical inter-enclosure (EL)	
5	6	OC 12, single mode long reach	8	7	Electrical intra-enclosure (EL)	
5	5	OC 12, single mode inter. reach	8	6	Shortwave laser w/o OFC (SN)	
5	4	OC 12 multi-mode short reach	8	5	Shortwave laser w/ OFC (SL)	
5	3	Reserved	8	4	Longwave laser (LL)	
5	2	OC 3, single mode long reach	8	0-3	Reserved	
5	1	OC 3, single mode inter. reach				
5	0	OC 3, multi-mode short reach	F	ibre C	hannel transmission media	
			9	7	Twin Axial Pair (TW)	
			9	6	Shielded Twisted Pair (TP)	
			9	5	Miniature Coax (MI)	
	Gigab	it Ethernet Compliance Codes	9	4	Video Coax (TV)	
6	7-4	Reserved	9	3	Multi-mode, 62.5m (M6)	
6	3	1000BASE-T	9	2	Multi-mode, 50 m (M5)	
6	2	1000BASE-CX	9	1	Reserved	
6	1	1000BASE-LX	9	0	Single Mode (SM)	
6	0	1000BASE-SX				
				F	ibre Channel speed	
			10	7-5	Reserved	
			10	4	400 MBytes/Sec	
			10	3	Reserved	
			10	2	200 MBytes./Sec	
			10	1	Reserved	
			10	0	100 MBytes/Sec	

Table 3.4. Transceiver codes

¹ Bit 7 is the high order bit and is transmitted first in each byte.

Encoding

The encoding value indicates the serial encoding mechanism that is the nominal design target of the particular SFP with OM transceiver. The value shall be contained in the serial data. The defined encoding values are shown in Table 3.5.

Code	Description of encoding mechanism
00h	Unspecified
01h	8B10B
02h	4B5B
03h	NRZ
04h	Manchester
05h -FFh	Reserved

Table 3.5. Encoding codes

BR, nominal

The nominal bit rate (BR, nominal) is specified in units of 100 Megabits per second, rounded off to the nearest 100 Megabits per second. The bit rate includes those bits necessary to encode and delimit the signal as well as those bits carrying data information. A value of 0 indicates that the bit rate is not specified and must be determined from the transceiver technology. The actual information transfer rate will depend on the encoding of the data, as defined by the encoding value.

Length (9m)-km

Addition to EEPROM data from original GBIC definition. This value specifies the link length that is supported by the SFP with OM transceiver while operating in compliance with the applicable standards using single mode fiber. The value is in units of kilometers. A value of 255 means that the transceiver supports a link length greater than 254 km. A value of zero means that the transceiver does not support single mode fiber or that the length information must be determined from the transceiver technology.

Length (9m)

This value specifies the link length that is supported by the SFP with OM transceiver while operating in compliance with the applicable standards using single mode fiber. The value is in units of 100 meters. A value of 255 means that the transceiver supports a link length greater than 25.4 km. A value of zero means that the SFP with OM transceiver does not support single mode fiber or that the length information must be determined from the transceiver technology.

Length (50m)

This value specifies the link length that is supported by the SFP with OM transceiver while operating in compliance with the applicable standards using 50 micron multi-mode fiber. The value is in units of 10 meters. A value of 255 means that the SFP with OM transceiver supports a link length greater than 2.54 km. A value of zero means that the transceiver does not support 50 micron multi-mode fiber or that the length information must be determined from the transceiver technology.

Length (62.5m)

This value specifies the link length that is supported by the SFP with OM transceiver while operating in compliance with the applicable standards using 62.5 micron multi-mode fiber. The value is in units of 10 meters. A value of 255 means that the SFP with OM transceiver supports a link length greater than 2.54 km. A value of zero means that the SFP with OM transceiver does not 62.5 micron multi-mode fiber or that the length information must determined from the transceiver technology. It is common for the SFP with OM transceiver to support both 50 micron and 62.5 micron fiber.

Length (Copper)

This value specifies the minimum link length that is supported by the SFP with OM transceiver while operating in compliance with the applicable standards using copper cable. The value is in units of 1 meter. A value of 255 means that the SFP with OM transceiver supports a link length greater than 254 meters. A value of zero means that the SFP with OM transceiver does not support copper cables or that the length information must be determined from the transceiver technology. Further information about the cable design, equalization, and connectors is usually required to guarantee meeting a particular length requirement.

Vendor name

The vendor name is a 16 character field that contains ASCII characters, left-aligned and padded on the right with ASCII spaces (20h). The vendor name shall be the full name of the corporation, a commonly accepted abbreviation of the name of the corporation, the SCSI company code for the corporation, or the stock exchange code for the corporation. At least one of the vendor name or the vendor OUI fields shall contain valid serial data.

Vendor OUI

The vendor organizationally unique identifier field (vendor OUI) is a 3-byte field that contains the IEEE Company Identifier for the vendor. A value of all zero in the 3-byte field indicates that the Vendor OUI is unspecified.

Vendor PN

The vendor part number (vendor PN) is a 16-byte field that contains ASCII characters, left-aligned and padded on the right with ASCII spaces (20h), defining the vendor part number or product name. A value of all zero in the 16-byte field indicates that the vendor PN is unspecified.

Vendor Rev

The vendor revision number (vendor rev) is a 4-byte field that contains ASCII characters, leftaligned and padded on the right with ASCII spaces (20h), defining the vendor's product revision number. A value of all zero in the 4-byte field indicates that the vendor Rev is unspecified.

CC_BASE

The check code is a one byte code that can be used to verify that the first 64 bytes of serial information in the SFP with OM transceiver is valid. The check code shall be the low order 8 bits of the sum of the contents of all the bytes from byte 0 to byte 62, inclusive.

Options

The bits in the option field shall specify the options implemented in the SFP with OM transceiver as described in Table 3.6.

Data Address Bi		Description of option
64	7-0	Reserved
65	7	Reserved
65	6	FEEDBACK DISABLE is implemented
		If this bit is set then pin 7 is used to margin the transmitter
		If this bit is set then bit 5 is must he low since the two signals
		share the same pin.
65	5	RATE_SELECT is implemented
		If bit is set then active control of the rate select pin is required
		to change rates. If bit is not set, no control of pin is required.
		In all cases, compliance with multiple rate standards should
		be determined by Transceiver Codes in Bytes 4, 5, 6 and 10.
		(See Table 3.4)
65	4	Tx_Disable is implemented and disables the serial output.
65	3	Tx_Fault signal implemented. (Reset defined in section III)
65	2	Loss of Signal implemented, signal inverted from definition in
		Table 1
		NOTE: This is not standard SFP with OM transceiver behavior
		and should be avoided, since non-interoperable behavior
		results.
65	1	Loss of Signal implemented, signal as defined in Table 1
65	0	Reserved

Table 3.6. Option Values

BR, max

The upper bit rate limit at which the SFP with OM transceiver will still meet its specifications (BR, max) is specified in units of 1% above the nominal bit rate. A value of zero indicates that this field is not specified.

BR, min

The lower bit rate limit at which the SFP with OM transceiver will still meet its specifications (BR, min) is specified in units of 1% below the nominal bit rate. A value of zero indicates that this field is not specified.

Vendor SN

The vendor serial number (vendor SN) is a 16 character field that contains ASCII characters, leftaligned and padded on the right with ASCII spaces (20h), defining the vendor's serial number for the SFP with OM transceiver. A value of all zero in the 16-byte field indicates that the vendor SN is unspecified.

Date Code

The date code is an 8-byte field that contains the vendor's date code in ASCII characters. The date code is mandatory. The date code shall be in the format specified by Table 3.7.

Data Address		Description of field
	84-85	ASCII code, two low order digits of year. (00 = 2000).
		ASCII code, digits of month (01 = Jan through 12 = Dec)
	88-89	ASCII code, day of month (01 - 31)
	90-91	ASCII code, vendor specific lot code, may be blank

Table 3.7.Date Code

CC_EXT

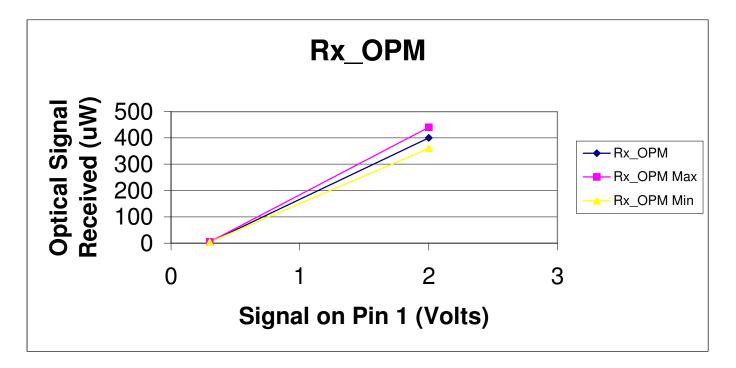
The check code is a one byte code that can be used to verify that the first 32 bytes of extended serial information in the SFP with OM transceiver is valid. The check code shall be the low order 8 bits of the sum of the contents of all the bytes from byte 64 to byte 94, inclusive.

Optical Monitoring Calibration Data

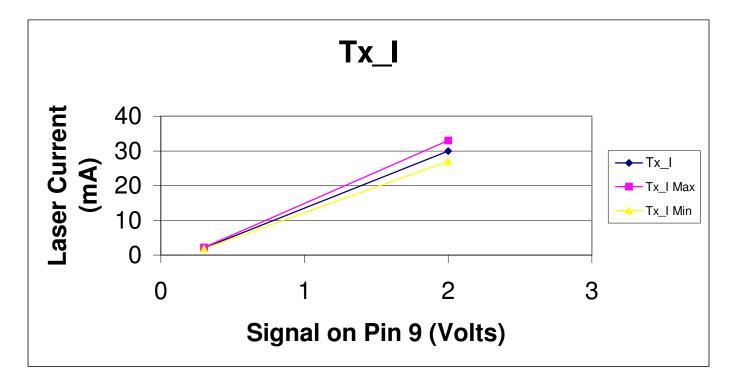
These bytes contain the calibration constants used to convert the output voltage into the measurement of interest.

B5. Optical Monitoring Definition

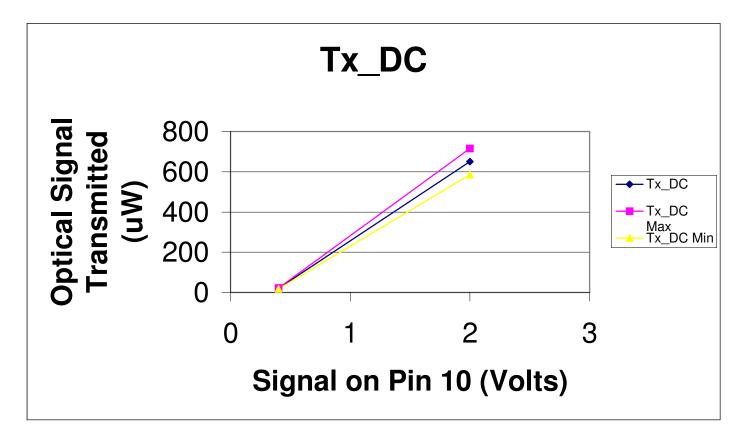
Sample output of Rx_OPM - Receiver Optical Power Meter



Sample output of Tx_I - Transmitter Laser Diode Current



Sample output of Tx_DC - Transmitter Power Output



(MSA)

Appendix C. Agreement Signatures

A. For EMC Corporation by:

Signed

Name

Title

Date

B. For IBM Inc. by:

Signed

Name

Title

Date